NOT RECOMMENDED FOR NEW DESIGN USE DMN2058UW



DMN2065UW

20V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _A = +25°C
20V	$56m\Omega @ V_{GS} = 4.5V$	2.8A
	$65m\Omega$ @ $V_{GS} = 2.5V$	2.6A
	$93m\Omega @ V_{GS} = 1.8V$	2.2A
	140mΩ @ V _{GS} = 1.5V	1.8A

Description and Applications

This MOSFET has been designed to minimize the on-state resistance (R_{DS(ON)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

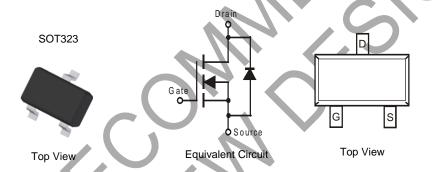
- General Purpose Interfacing Switch
- Power Management Functions
- DC-DC Converters
- Analog Switch

Features and Benefits

- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- An Automotive-Compliant Part is Available Under Separate Datasheet (<u>DMN2065UWQ</u>)

Mechanical Data

- Case: SOT323
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Alloy42 Leadframe.
 Solderable per MIL-STD-202, Method 208 3
- Weight: 0.027 grams (Approximate)



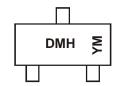
Ordering Information (Note 4)

Part Number	Case	Packaging
DMN2065UW-7	SOT323	3000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



DMH = Product Type Marking Code YM = Date Code Marking Y = Year (ex: F = 2018) M = Month (ex: 9 = September)

Date Code Key

Year	201	8	2019		2020	20	21	2022		2023	2	2024
Code	F		G		Н		l	J		K		L
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



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Maximum Ratings ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V_{DSS}	20	V		
Gate-Source Voltage	V _{GSS}	±12	V		
Continuous Dusin Courset (Note C) V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	2.8 2.3	А
Continuous Drain Current (Note 6) V _{GS} = 4.5V	t<10s	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	3.1 2.6	Α
Continuous Dusin Courset (Note C) // 4 0)/	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	2.2 1.7	Α	
Continuous Drain Current (Note 6) V _{GS} = 1.8V	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	2.4 1.9	А	
Pulsed Drain Current (10us Pulse, Duty Cycle=1%)	I _{DM}	30	Α		
Maximum Body Diode Forward Current (Note 5)	Is	1.2	Α		

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)		P_{D}	0.43	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	D	296	°C/W
Themal Resistance, sunction to Ambient (Note 5)	t<10s	$R_{\theta JA}$	252	°C/W
Total Power Dissipation (Note 6)		Po	0.7	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	D	178	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	R_{θ} JA	151	°C/W
Operating and Storage Temperature Range		$T_{J_1} T_{STG}$	-55 to +150	ů

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

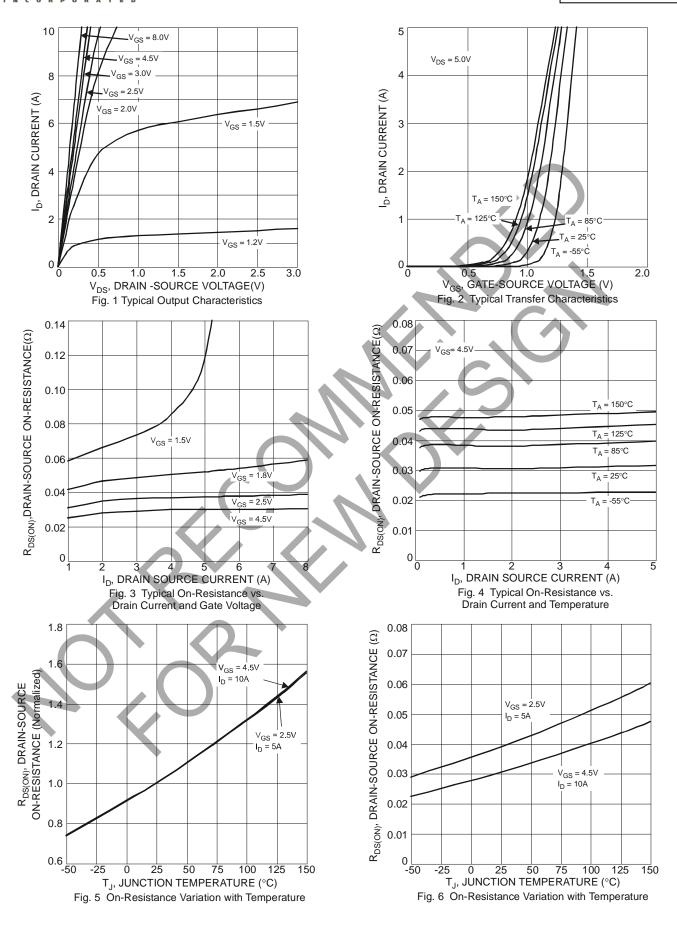
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						•
Drain-Source Breakdown Voltage	BV _{DSS}	20	-	-	V	$V_{GS} = 0V$, $I_D = 1mA$
Zero Gate Voltage Drain Current @Tc = +25°C	IDSS	-	-	1	μΑ	$V_{DS} = 20V$, $V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	-	ı	±1	μΑ	$V_{GS} = \pm 10V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	$V_{GS(TH)}$	0.35	-	1.0	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
		-	52	56		$V_{GS} = 4.5V, I_D = 2A$
Static Drain-Source On-Resistance		-	59	65	mΩ	$V_{GS} = 2.5V, I_D = 2A$
Static Dialii-Source Off-Resistance	R _{DS(ON)}	-	60	93	11122	$V_{GS} = 1.8V, I_D = 1A$
		-	75	140		$V_{GS} = 1.5V, I_D = 0.5A$
Forward Transfer Admittance	Y _{fs}	-	7	-	S	$V_{DS} = 5V, I_D = 3.8A$
Diode Forward Voltage	V_{SD}	-	0.7	1.0	V	$V_{GS} = 0V, I_{S} = 1A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{iss}	-	400.0	-	pF	101/1/
Output Capacitance	Coss	-	73.8	-	рF	$V_{DS} = 10V, V_{GS} = 0V,$ - f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	-	65.6	1	рF	1 = 1.01/11/12
Total Gate Charge	Q_{g}	-	5.4	-	nC	$V_{GS} = 4.5V, V_{DS} = 10V,$
Gate-Source Charge	Q _{gs}	-	0.7	-	nC	$I_D = 6A$
Gate-Drain Charge	Q_{gd}	-	1.4	-	nC	
Turn-On Delay Time	t _{D(ON)}	-	3.5	-	ns	
Turn-On Rise Time	t _R	-	9.7	-	ns	$V_{DD} = 10V, V_{GS} = 5V,$
Turn-Off Delay Time	t _{D(OFF)}	-	23.8	-	ns	$R_L = 1.7\Omega$, $R_G = 6\Omega$
Turn-Off Fall Time	t _F	-	7.2	-	ns	

Notes: 5. Device mounted on FR-4 substrate PC board, with minimum recommended pad layout.

- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.
- 7. Short duration pulse test used to minimize self-heating effect.
- 8. Guaranteed by design. Not subject to product testing.

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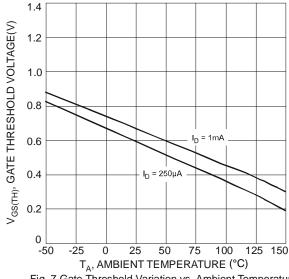
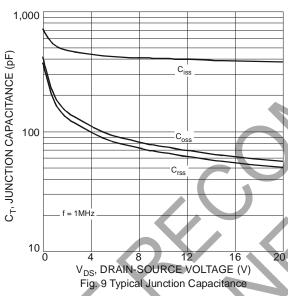
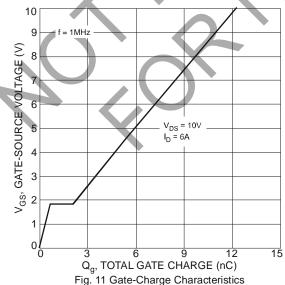
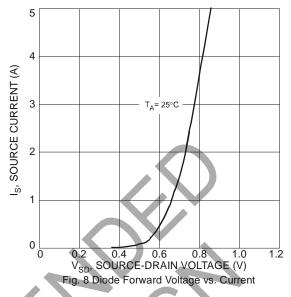


Fig. 7 Gate Threshold Variation vs. Ambient Temperature







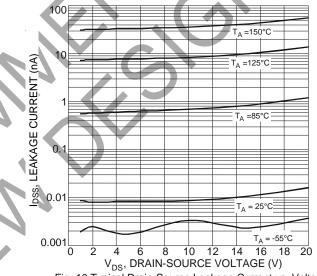
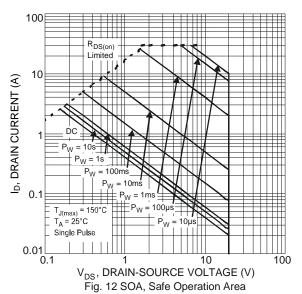


Fig. 10 Typical Drain-Source Leakage Current vs. Voltage



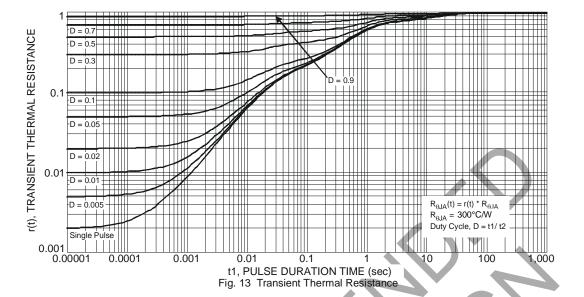




March 2018

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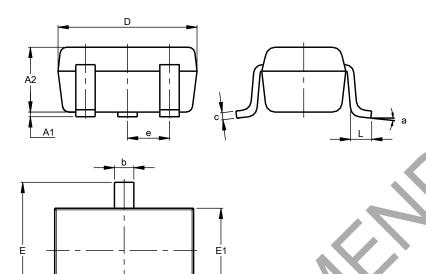




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT323

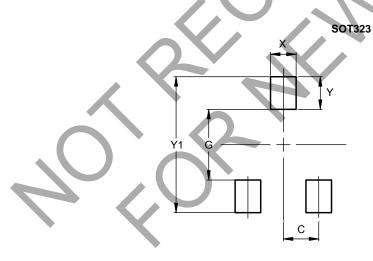


SOT323								
Dim	Min	Max	Тур					
A1	0.00	0.10	0.05					
A2	0.90	1.00	0.95					
b	0.25	0.40	0.30					
С	0.10	0.18	0.11					
D	1.80	2.20	2.15					
E	2.00	2.20	2.10					
E1	1.15	1.35	1.30					
е	C	0.650 BSC						
e1	1.20	1.40	1.30					
F	0.375	0.475	0.425					
L	0.25	0.40	0.30					
а	0°	8°						
All	All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

e1



Dimensions	Value (in mm)
C	0.650
G	1.300
X	0.470
Y	0.600
Y1	2.500



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